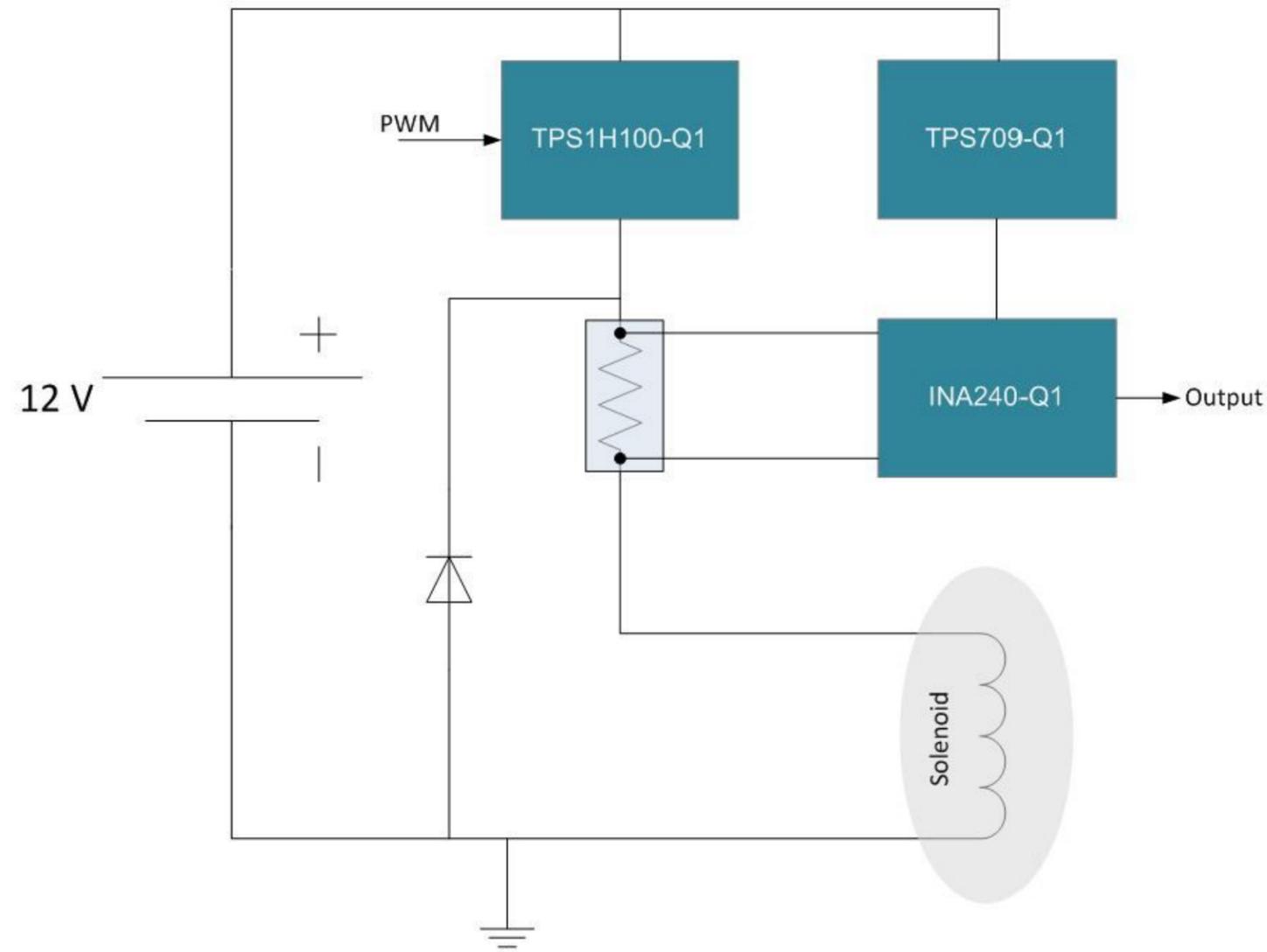


Revision History

Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A

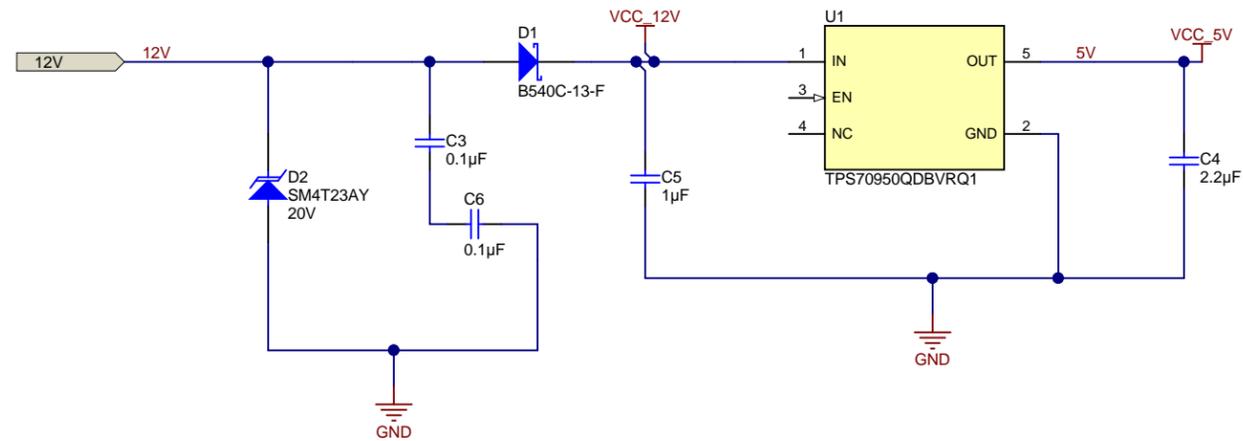


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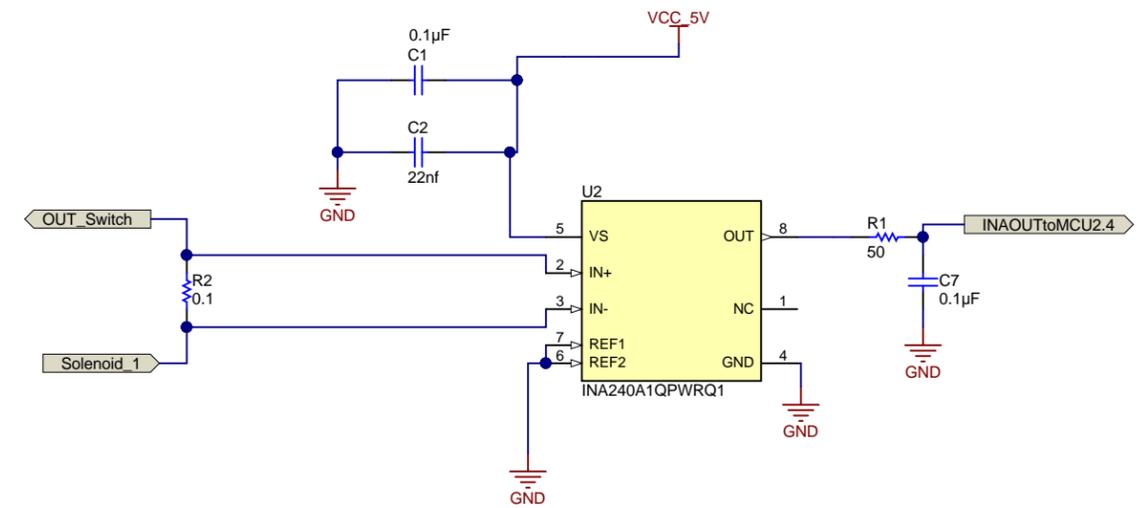
Orderable: N/A	Designed for: Public Release	Mod. Date: 12/5/2017	 <a href="http://www.ti.com">http://www.ti.com</a>
TID #: TIDA-01506	Project Title: Reference Design for Automotive, Proportional-Sole	Sheet: 1 of 3	
Number: TIDA-01506	Rev: E1	Assembly Variant: [No Variations]	Size: B
SVN Rev: Version control disabled	File: CoverSheet.SchDoc	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	
Drawn By:	Engineer: Sandeep Tallada		



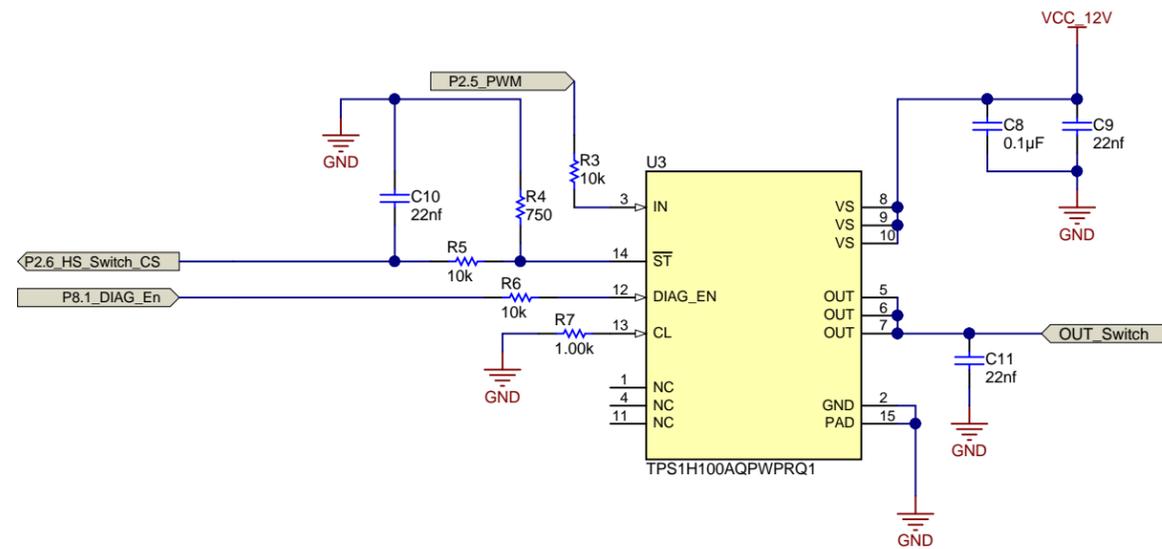
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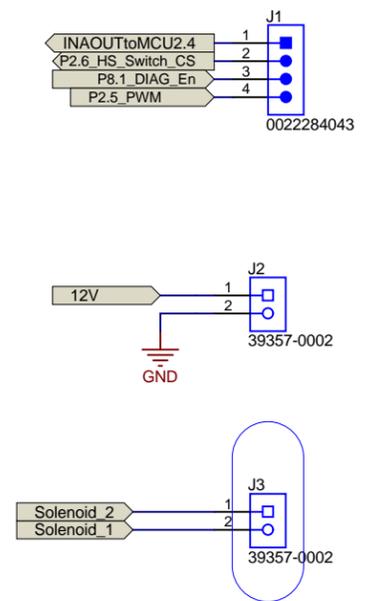
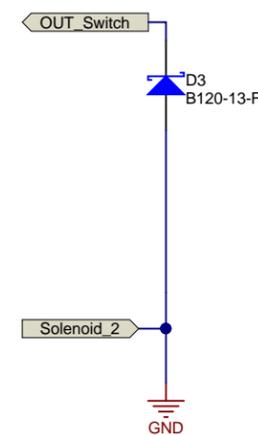
Power Supply section



Current Shunt Monitor



High Side Switch



Connectors

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TID #: TIDA-01506	Project Title: Reference Design for Automotive, Proportional-Sole		
Number: TIDA-01506	Rev: E1	Sheet Title:	http://www.ti.com
SVN Rev: Version control disabled		Assembly Variant: [No Variations]	
Drawn By: Sandeep Tallada		File: TIDA-01506_Schematics.SchDoc	Size: B
Engineer: Sandeep Tallada		Contact: http://www.ti.com/support	© Texas Instruments 2017

PCB Number: TIDA-01506  
PCB Rev: E1

PCB  
LOGO

PCB  
LOGO

PCB  
LOGO

Variant/Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: N/A	Designed for: Public Release	Mod. Date: 12/15/2017	 TEXAS INSTRUMENTS <a href="http://www.ti.com">http://www.ti.com</a> © Texas Instruments 2017
TID #: TIDA-01506	Project Title: Reference Design for Automotive, Proportional-Sole		
Number: TIDA-01506	Rev: E1	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 3 of 3	
Drawn By: Sandeep Tallada	File: EVM_Hardware.SchDoc	Size: B	
Engineer: Sandeep Tallada	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		

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